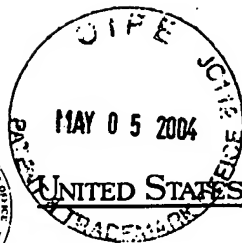


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Method and apparatus for supporting microelectronic substrates

**Preliminary Class**

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